Electronic Acknowledgement Receipt FES ID: 1186135 Application Number: 10690782 Confirmation Number: 5611 Title of Invention: Method for manufacturing a wafer level chip scale package First Named Inventor: Jin-Hyuk Lee Customer Number: 20575 Filer: Hosoon Lee/Stormi Davis Filer Authorized By: Hosoon Lee Attorney Docket Number: 9903-071 Receipt Date: 05-SEP-2006 Filing Date: 21-OCT-2003 Time Stamp: 17:28:37 Application Type: Utility International Application Number: Payment information:

File Listing:

Submitted with Payment

| Document Number | Document Description | File Name | File Size(Bytes) | Multi Part | Pages |
|--------------------|----------------------|--------------|------------------|---------------|-------|
| 1 | | 9903071c.pdf | 964126 | yes | 13 |

no

| | Multipart Description | | | | |
|-----------|---------------------------------------|-------|-----|--|--|
| | Doc Desc | Start | End | | |
| | Miscellaneous Incoming Letter | 1 | 1 | | |
| | Amendment - After Non-Final Rejection | 2 | 13 | | |
| Warnings: | | | | | |

Warnings:

Information:

Total Files Size (in bytes):

964126

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt. in due course.